

## Description

The PPM6N30V8 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

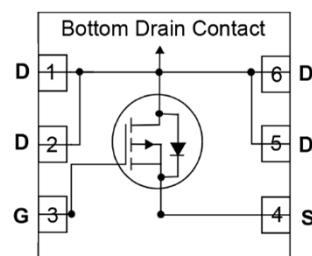
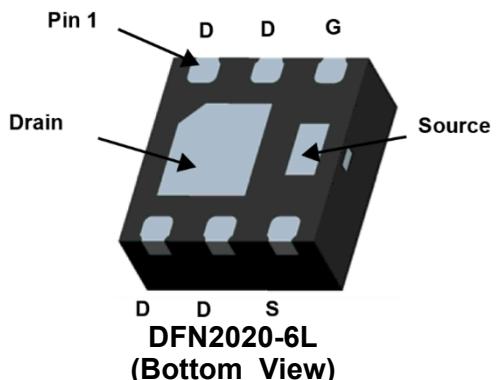
MOSFET Product Summary		
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (mΩ)(Typ)	I <sub>D</sub> (A)
-30	27 @ V <sub>GS</sub> =-10V	-8

## Feature

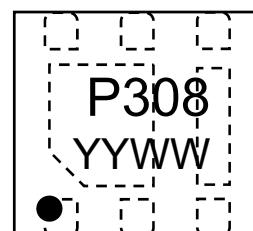
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

## Applications

- PWM applications
- Load switch
- Power management



**Circuit Diagram**



**Marking (Top View)**

## Absolute maximum rating@25°C

Rating	Symbol	Value	Units
Drain-source Voltage	V <sub>DS</sub>	-30	V
Gate-source Voltage	V <sub>GS</sub>	±20	V
Drain Current	I <sub>D</sub>	-8.0	A
Total Power Dissipation	P <sub>D</sub>	2.1	W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~+150	°C

## Thermal Characteristics

Rating	Symbol	Value	Units
Thermal Resistance, Junction to Ambient <sup>1)</sup>	R <sub>θJA</sub>	59	°C/W
Thermal Resistance, Junction to Ambient <sup>2)</sup>	R <sub>θJA</sub>	143	°C/W
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	8.0	°C/W

# P-Channel MOSFET

PPM6N30V8

## Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-30	-	-	V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -24V, V_{GS} = 0V$	-	-	-1.0	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	$\pm 100$	nA
On Characteristics <sup>3)</sup>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1.1	-1.5	-1.9	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS} = -4.5V, I_D = -4A$	-	30	45	$m\Omega$
		$V_{GS} = -10V, I_D = -5A$	-	27	41	
Forward Transconductance	$g_{FS}$	$V_{DS} = -5V, I_D = -9A$	21	-	-	S
Dynamic Parameters <sup>4)</sup>						
Input Capacitance	$C_{iss}$	$V_{DS} = -15V, V_{GS} = 0V, f = 1MHz$	-	650	-	$pF$
Output Capacitance	$C_{oss}$		-	90	-	
Reverse Transfer Capacitance	$C_{rss}$		-	80	-	
Switching Parameters <sup>4)</sup>						
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = -15V, I_D = -9A, V_{GS} = -10V, R_{GEN} = 6\Omega$	-	4.5	-	$ns$
Turn-on Rise Time	$t_r$		-	21	-	
Turn-Off Delay Time	$t_{d(off)}$		-	24	-	
Turn-Off Fall Time	$t_f$		-	31	-	
Total Gate Charge	$Q_g$	$V_{DD} = -15V, I_D = -9A, V_{GS} = -10V$	-	15.3	-	$nC$
Gate-Source Charge	$Q_{gs}$		-	1.7	-	
Gate-Drain Charge	$Q_{gd}$		-	3.6	-	
Drain-Source Diode Characteristics						
Diode Forward Voltage <sup>3)</sup>	$V_{SD}$	$V_{GS} = 0V, I_S = -2A$	-	-0.6	-1.2	V
Diode Forward Current <sup>2)</sup>	$I_S$	-	-	-	2.5	A

### Notes:

1. Surface mounted on FR4 Board using 1 square inch pad size, 1oz copper
2. Surface mounted on FR4 board using minimum pad size, 1oz copper
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

## Typical Characteristics

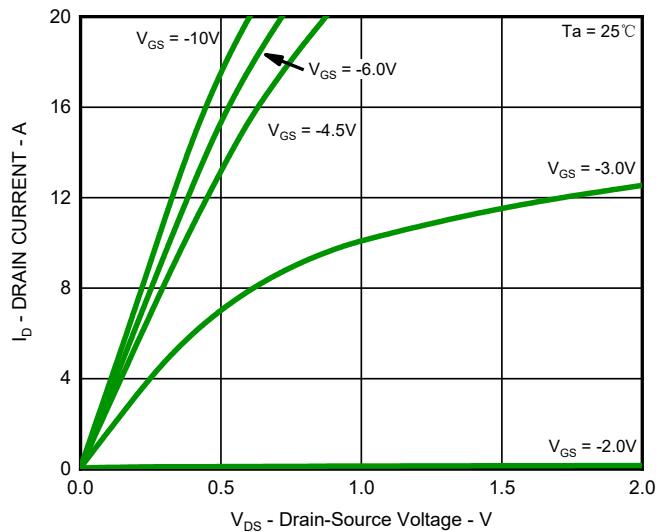


Fig.1 Output Characteristics

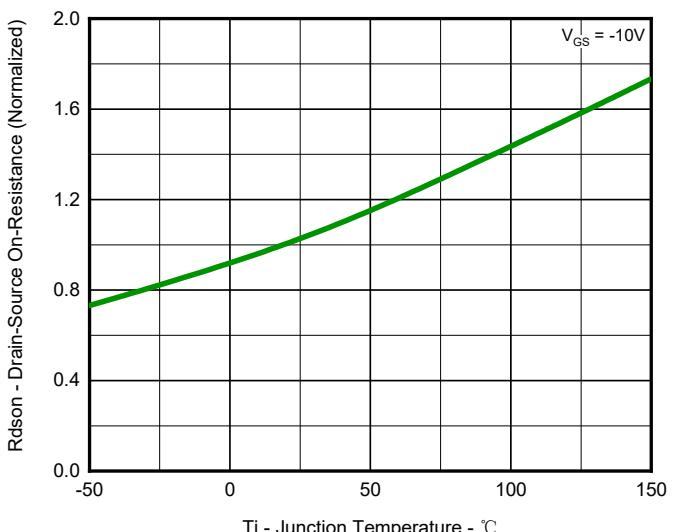


Fig.2 On-Resistance Variation with Temperature

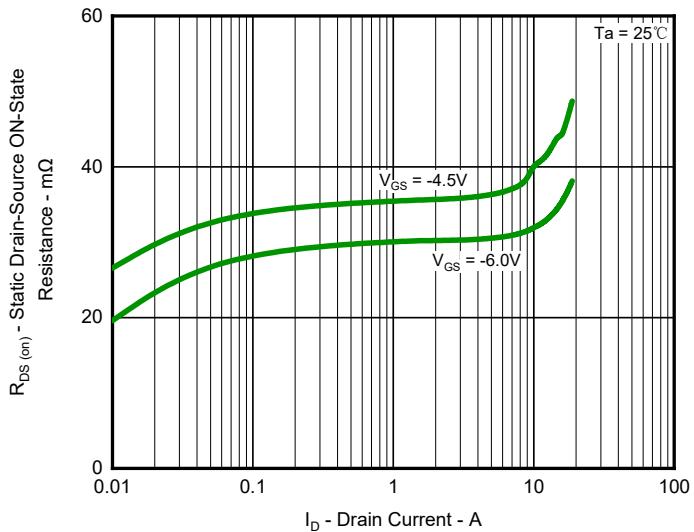


Fig.3 On-Resistance vs. Drain Current

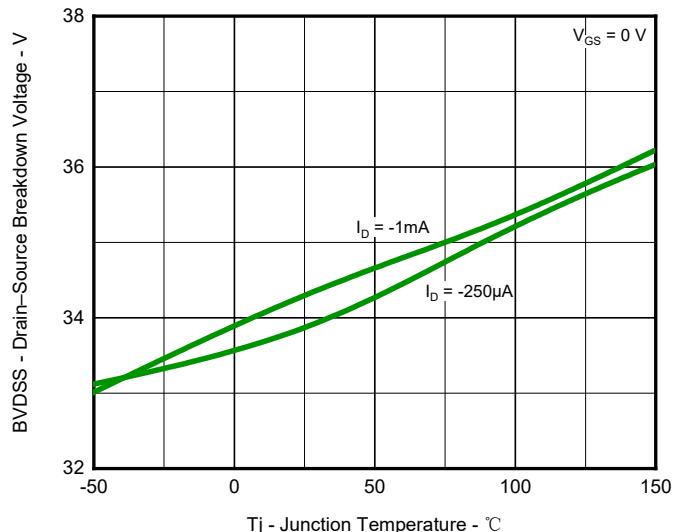


Fig.4 BVDSS vs Junction Temperature

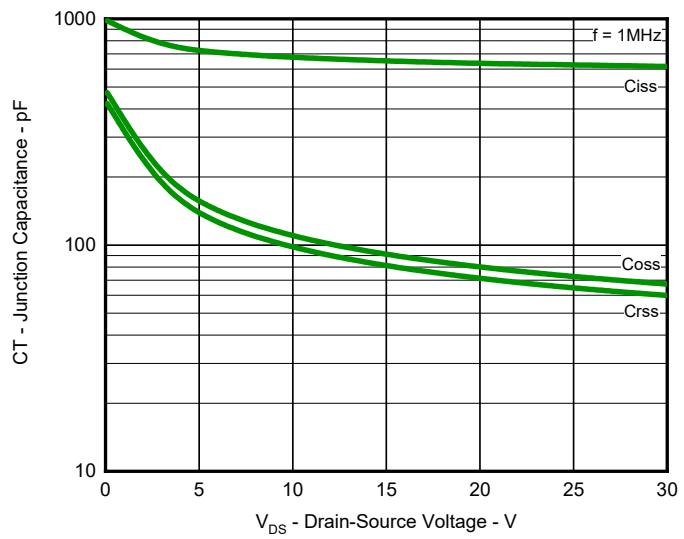


Fig.5 Typical Junction Capacitance

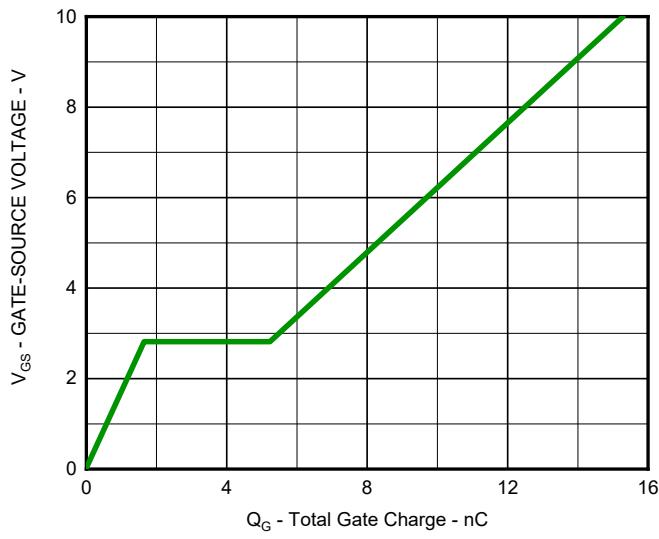


Fig.6 Gate Charge Characteristics

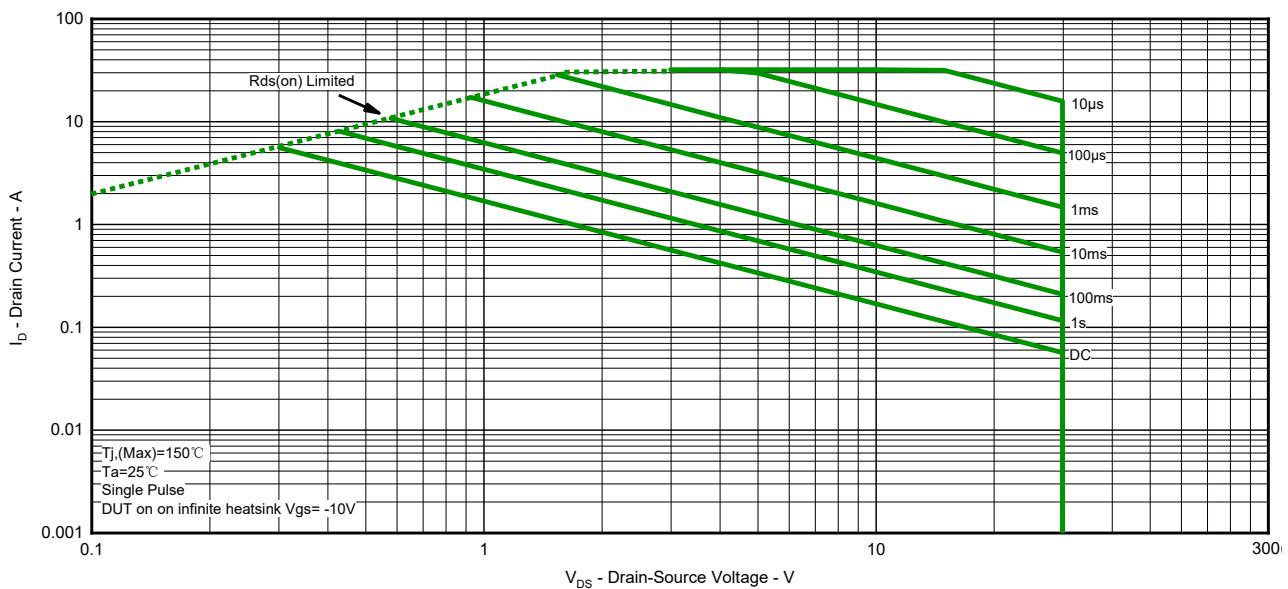


Fig.7 Safe Operation Area

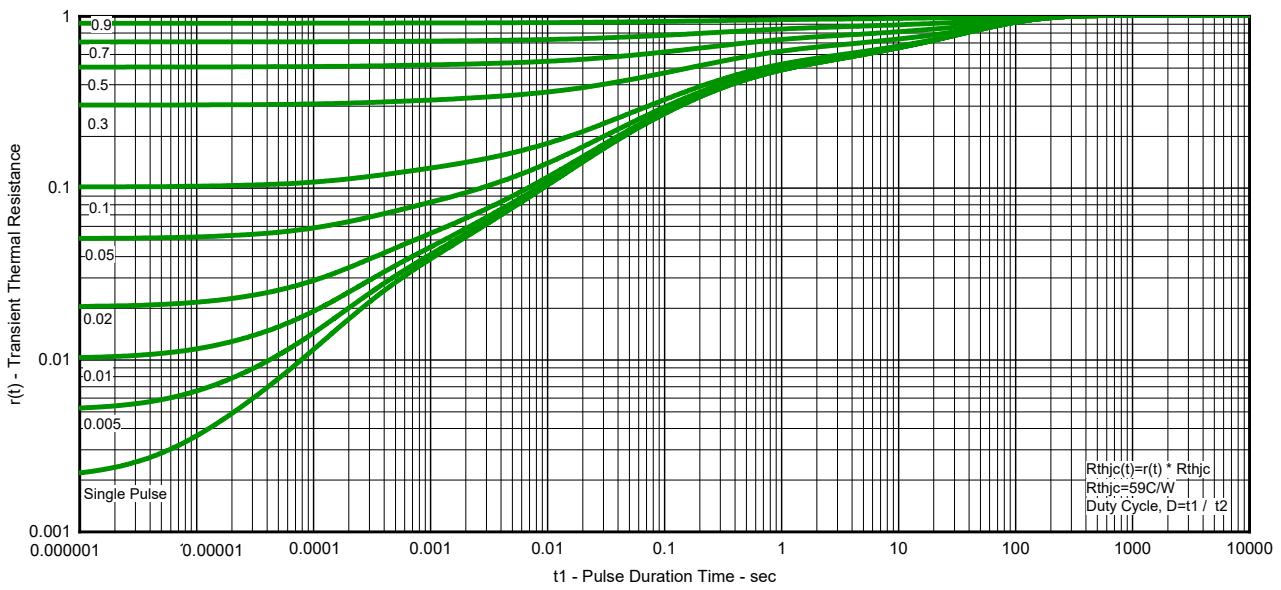
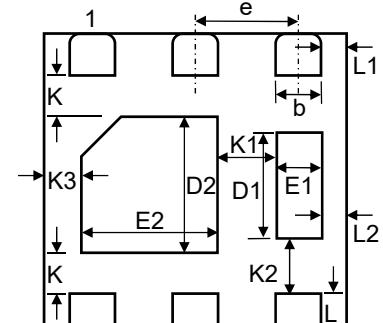
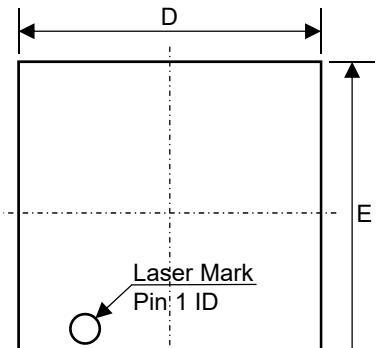
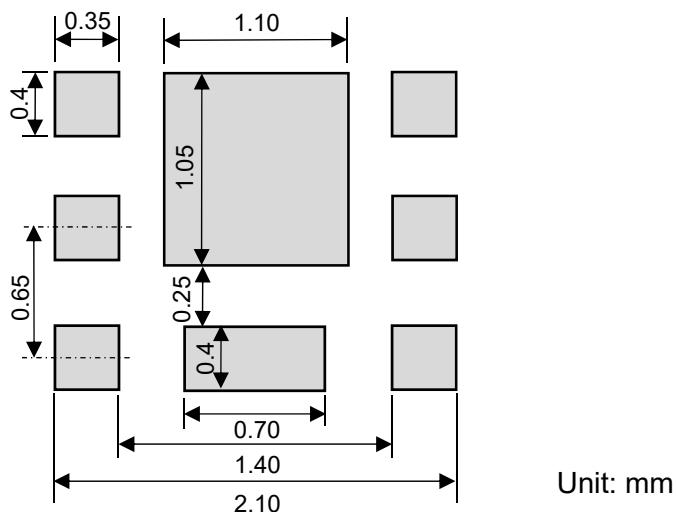


Fig.8 Transient Thermal Resistance

## Product dimension (DFN2020-6L)



Dim	Millimeters		Inches		Dim	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
A	0.70	0.80	0.028	0.031	E2	0.80	1.00	0.031	0.039
A1	0.00 0.05		0.000 0.002		e	0.65 BSC.		0.026 BSC.	
A2	0.203 Ref.		0.008 Ref.		K	0.275 Ref.		0.011 Ref.	
b	0.25	0.35	0.010	0.014	K1	0.35 Ref.		0.014 Ref.	
D	1.90	2.10	0.075	0.083	K2	0.47 Ref.		0.019 Ref.	
D1	0.46	0.66	0.018	0.026	K3	0.25 Ref.		0.010 Ref.	
D2	0.85	1.05	0.033	0.041	L	0.20	0.30	0.008	0.012
E	1.90	2.10	0.075	0.083	L1	0.20 Ref.		0.008 Ref.	
E1	0.20	0.40	0.008	0.016	L2	0.20 Ref.		0.008 Ref.	

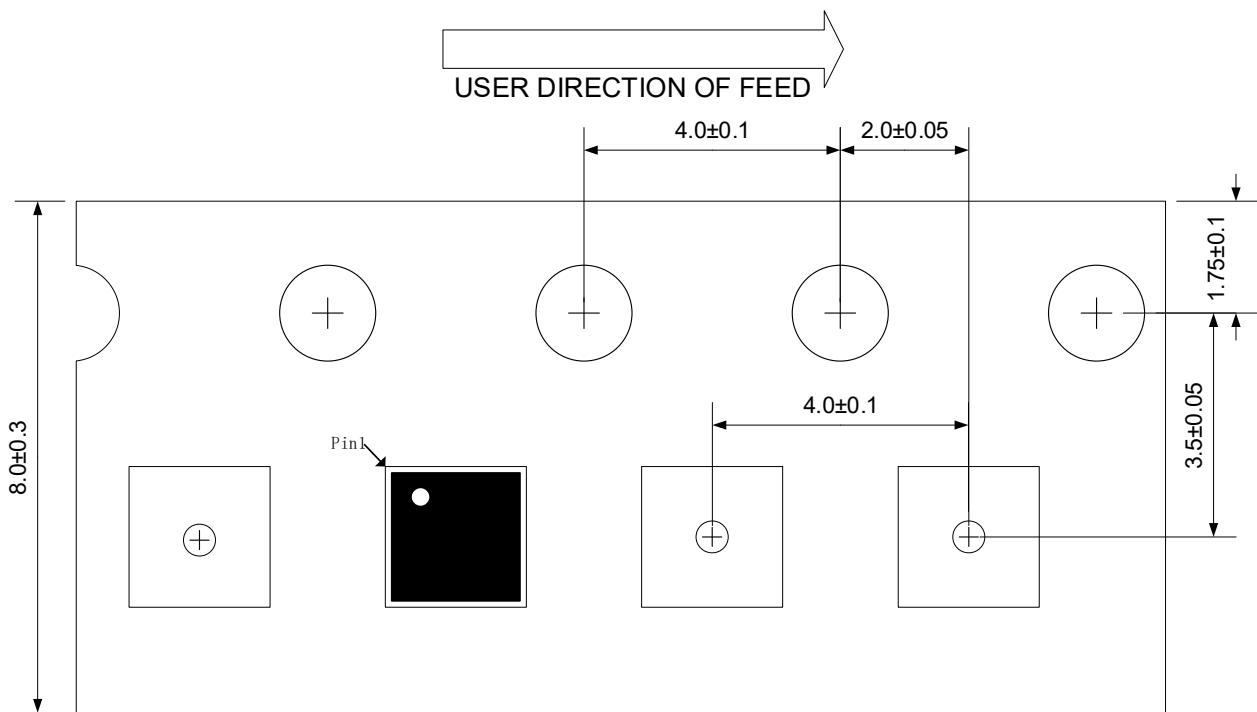


Suggested PCB Layout

## P-Channel MOSFET

PPM6N30V8

### Load with information



Unit:mm

### Ordering information

Device	Package	Reel	Shipping
PPM6N30V8	DFN2020-6L	7"	3000 / Tape & Reel

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